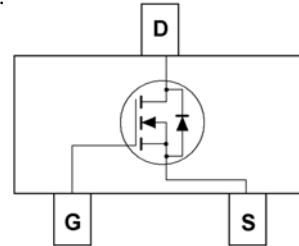# BSS138

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| **N-Channel Enhancement Mode MOSFET** |

Feature

- 50V/0.2A, $R_{DS(ON)} = 3.5\,\Omega$ (MAX) @$V_{GS} = 5V$. Id = 0.2A

  $R_{DS(ON)} = 10\,\Omega$ (MAX) @$V_{GS} = 2.75V$. Id = 0.2A

- Super High dense cell design for extremely low $R_{DS(ON)}$.

- Reliable and Rugged.

- Low Threshold Voltage (0.5V—1.5V) Make it Ideal for Low Voltage Applications.

- SOT-23 for Surface Mount Package.

SOT-23

Applications

- Power Management in DC/DC Converters、 Portable and Battery-powered Products.

Absolute Maximum Ratings T_A=25℃ Unless Otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	V_{DS}	50	V
Gate-Source Voltage	V_{GS}	$\pm$20	V
Drain Current-Continuous	I_D	0.2	A

Electrical Characteristics T_A=25℃ Unless Otherwise noted

Parameter	Symbol	Test Conditions	Min	Typ.	Max	Units
Off Characteristics						
Drain to Source Breakdown Voltage	BVDSS	VGS=0V, ID=250μA	50	-	-	V
Zero-Gate Voltage Drain Current	IDSS	VDS=50V, VGS=0V	-	-	0.5	μA
		VDS=25V, VGS=0V	-	-	0.1	
Gate Body Leakage Current, Forward	IGSSF	VGS=20V, VDS=0V	-	-	100	nA
Gate Body Leakage Current, Reverse	IGSSR	VGS=-20V, VDS=0V	-	-	-100	nA
On Characteristics						
Gate Threshold Voltage	VGS(th)	VGS= VDS, ID=1.0 mA	0.5	-	1.5	V
Static Drain-source On-Resistance	RDS(ON)	VGS =5.0V, ID =0.2A	-	-	3.5	Ω
		VGS =2.75V, ID =0.2A	-	-	10	Ω
Drain-Source Diode Characteristics and Maximum Ratings						
Drain-Source Diode Forward Voltage	VSD	VGS =0V, IS=0.2A			2.5	V

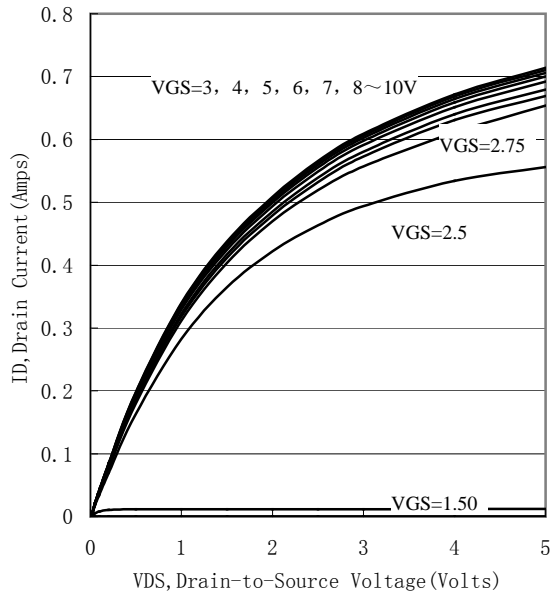## Typical Characteristics

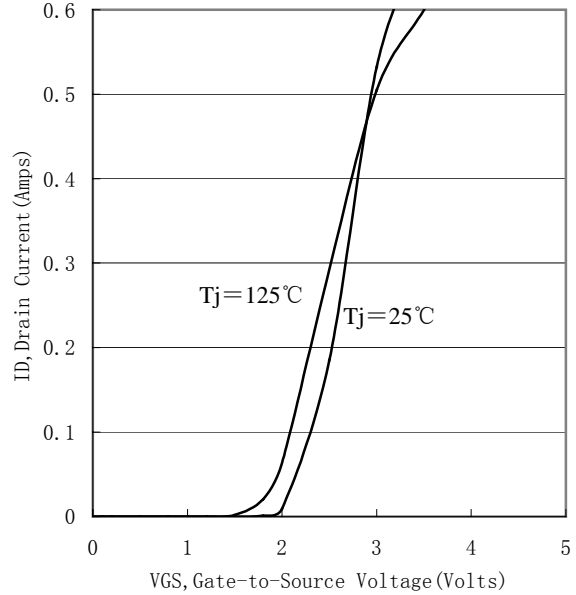**Figure 1．Output Characteristics**
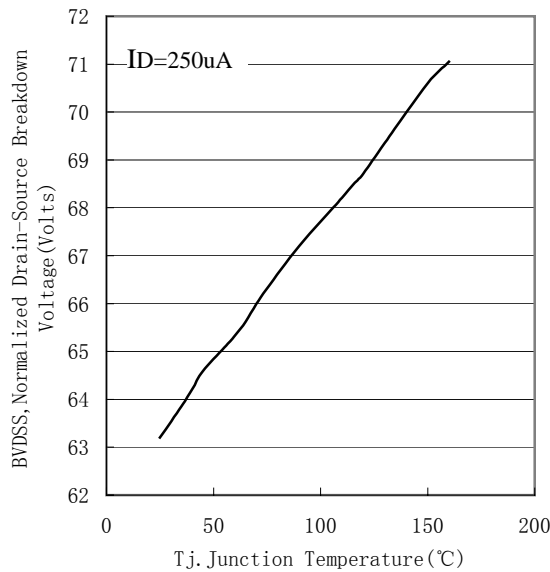

Figure 2．Transfer Characteristics

Figure 3．Breakdown Voltage Variation
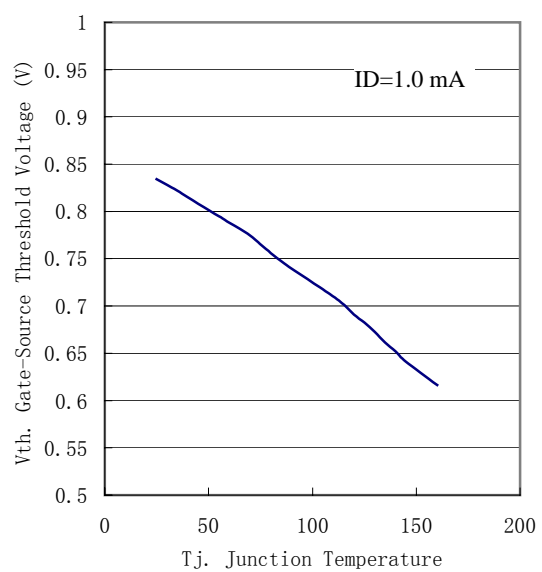**with Temperature**

Figure 4．Gate Threshold Variation
with Temperature

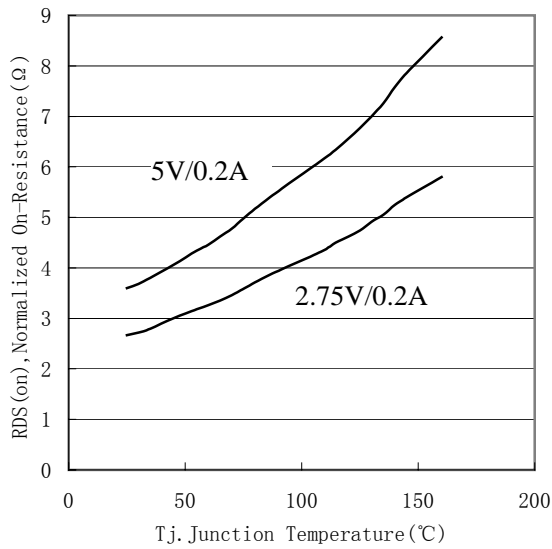## Typical Characteristics

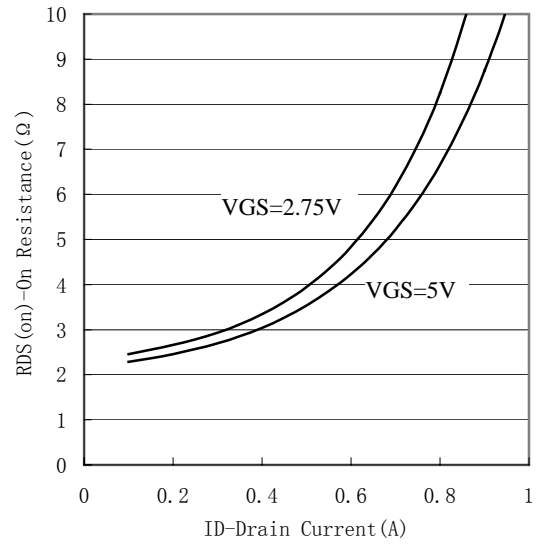**Figure 5．On-Resistance Variation with Temperature**

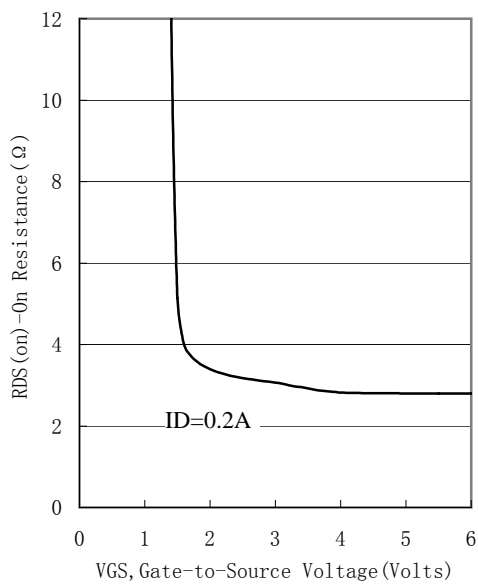
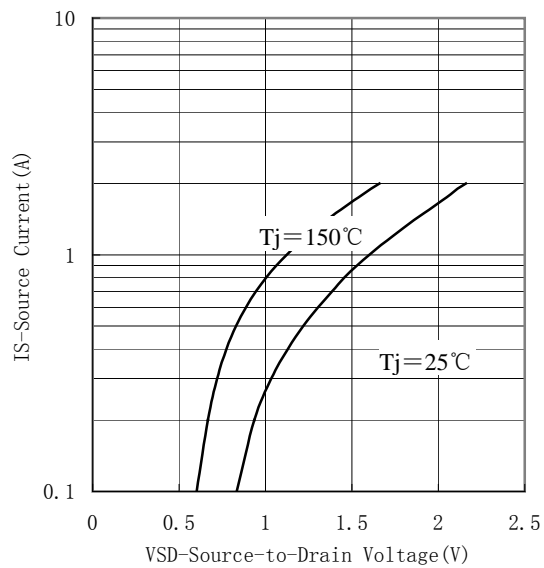**Figure 6．On-Resistance vs. Drain Current**

Figure 7．On-Resistance vs. Gate-to-Source Voltage

Figure 8．Source-Drain Diode Forward Voltage